



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2835
Examiner: Michael Datskovsky

In Re PATENT APPLICATION Of:

Applicant: Seiji ANDOH

Serial No.: 09/376,063

Filed: August 17, 1999

For: PACKAGE STRUCTURE FOR A
SEMICONDUCTOR DEVICE

Attorney Ref: OKI 226

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

June 5, 2001

Sir:

In response to the Office Action dated February 5, 2001, a Petition for
Extension of Time being attached, please amend the application as follows:

IN THE CLAIMS:

Please amend claim 24 and add new claims 26 - 29 as follows.

24. (Amended) The semiconductor device in accordance with Claim 22,
wherein said plurality of bumps included in said second bump unit is greater in
quantity than said plurality of bumps included in said first bump unit.

FILED ENCLOSURE: \$110
Please charge any further
fee to our Deposit Account
100-10-0112

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